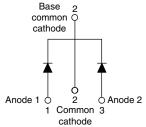


Ultrafast Rectifier, FRED Pt®, 2 x 30 A





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PRODUCT SUMMARY	
Package	TO-247AC
I _{F(AV)}	2 x 30 A
V _R	200 V
V _F at I _F	1.1 V
t _{rr} typ.	30 ns
T _J max.	175 °C
Diode variation	Common cathode

FEATURES

- · Ultrafast recovery time
- Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)





RoHS COMPLIANT HALOGEN FREE

DESCRIPTION

VS-60CPU02... series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, welding, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Repetitive peak reverse voltage	V _{RRM}		200	V				
Average rectified forward current — per I			30					
per devi	ce I _{F(AV)}	Rated V _R , T _C = 145 °C	60	Α				
Non-repetitive peak surge current per leg	I _{FSM}	T _J = 25 °C	300	A				
Peak repetitive forward current per leg	I _{FM}	Rated V _R , square wave, 20 kHz, T _C = 137 °C	60					
Operating junction and storage temperatures	T _J , T _{Stg}		- 65 to 175	°C				

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS MIN. TYP. MAX. U						
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-			
Famural valle as	V _F	I _F = 30 A	-	0.92	1.1	V		
Forward voltage	VF	I _F = 30 A, T _J = 150 °C	-	0.75	0.85			
Davaga laakaga ayuwant	,	V _R = V _R rated	=	-	50			
Reverse leakage current I _R		T _J = 150 °C, V _R = V _R rated	=	30	300	μΑ		
Junction capacitance	C _T	V _R = 200 V	=	100	-	pF		
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	12	-	nH		



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS	
		$I_F = 1.0 A, dI_F/dt =$	100 A/ μ s, $V_R = 30 V$	-	30	36		
Reverse recovery time	t _{rr}	T _J = 25 °C			30	-	ns	
		T _J = 125 °C		-	47	-		
Book rossyon, surrent		T _J = 25 °C	I _F = 30 A dI _F /dt = - 200 A/µs	-	3	-	Α	
Peak recovery current	I _{RRM}	T _J = 125 °C	V _R = 160 V	-	6.5	-	A	
Daviere receives about	0	T _J = 25 °C		-	42	-	nC	
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	160	-	IIC	

THERMAL - MECHANICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T _J , T _{Stg}		- 65	-	175	°C	
Thermal resistance, junction to case per leg	R _{thJC}		-	0.6	1.0		
Thermal resistance, junction to ambient per leg	R _{thJA}	Typical socket mount	-	-	40	°C/W	
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.5	-		
Weight			-	6.0	-	g	
vveigni			-	0.21	-	OZ.	
Mounting torque			6.0 (5.0)	-	12 (10)	kgf ⋅ cm (lbf ⋅ in)	
Marking device		Case style TO-247AC	60CPU02				

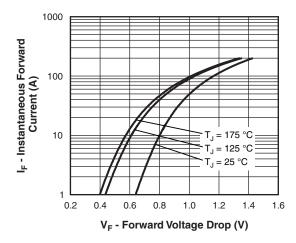


Fig. 1 - Typical Forward Voltage Drop Characteristics

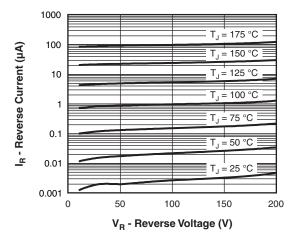


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

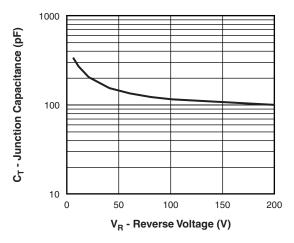


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

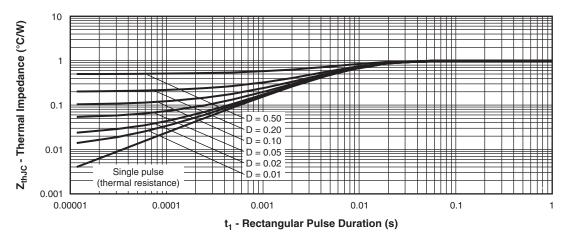


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

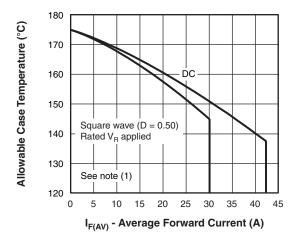


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

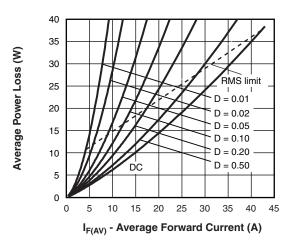


Fig. 6 - Forward Power Loss Characteristics

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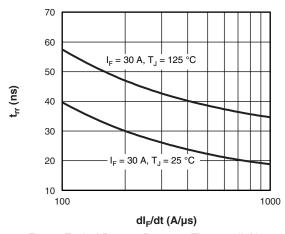


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt

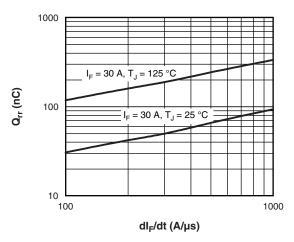


Fig. 8 - Typical Stored Charge vs. dl_F/dt

Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (\text{Pd} + \text{Pd}_{\text{REV}}) \times R_{\text{th}JC}; \\ \text{Pd} = \text{Forward power loss} = I_{\text{F(AV)}} \times V_{\text{FM}} \text{ at } (I_{\text{F(AV)}}/D) \text{ (see fig. 6)}; \\ \text{Pd}_{\text{REV}} = \text{Inverse power loss} = V_{\text{R1}} \times I_{\text{R}} (1 - D); I_{\text{R}} \text{ at } V_{\text{R1}} = \text{Rated } V_{\text{R}} \end{aligned}$

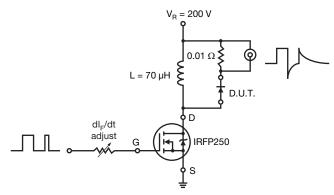
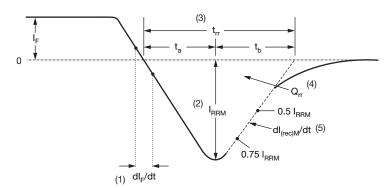


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (4) \mathbf{Q}_{rr} area under curve defined by \mathbf{t}_{rr} and \mathbf{I}_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

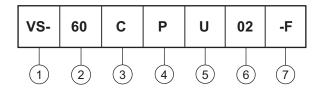
(5) dl_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (60 = 60 A)

3 - Circuit configuration:

C = Common cathode

- Package:

P = TO-247AC (modified)

5 - U = Ultrafast rectifier

6 - Voltage rating (02 = 200 V)

7 - Environmental digit:

-F = RoHS compliant and totally lead (Pb)-free

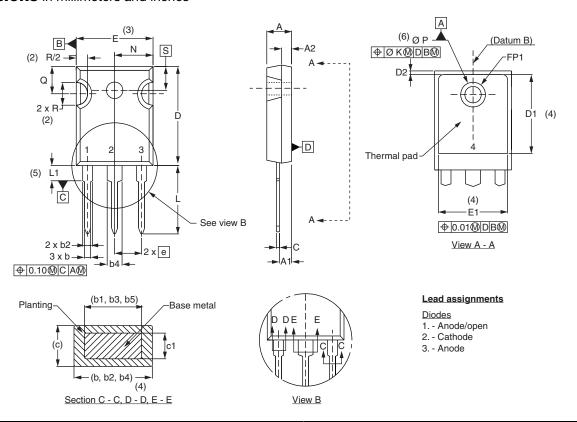
-N3 = Halogen-free, RoHS compliant and totally lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-60CPU02-F	25	500	Antistatic plastic tube					
VS-60CPU02-N3	25	500	Antistatic plastic tube					

LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95223</u>					
Part marking information	www.vishay.com/doc?95007				



DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	ILLIMETERS INCHES		INCHES	
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.37	0.065	0.094	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.86	0.015	0.034	
c1	0.38	0.76	0.015	0.030	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS INCI		INCHES		NOTES
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.72	-	0.540	-	
е	5.46	BSC	0.215	BSC	
FK	2.	54	0.010		
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
Ν	7.62 BSC		0.3		
ΦР	3.56	3.66	0.14	0.144	
ФР1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	1.78	0.216	
S	5.51	BSC	0.217 BSC		

Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC outline TO-247 with exception of dimension c



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Vishay

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